

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6306508

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	CHUN-YAO KU	05/05/2020
	WEN-HAO CHEN	05/05/2020
	MING-TAO YU	05/05/2020
RECEIVING PARTY DATA		
Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.	
Street Address:	NO. 8, LI-HSIN RD. VI, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	300	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	17025296	
CORRESPONDENCE DATA		
Fax Number:	(703)518-5499	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	7036841111	
Email:	tsmc@ipfirm.com	
Correspondent Name:	HAUPTMAN HAM, LLP (TSMC)	
Address Line 1:	2318 MILL ROAD	
Address Line 2:	SUITE 1400	
Address Line 4:	ALEXANDRIA, VIRGINIA 22314	
ATTORNEY DOCKET NUMBER:	T5057-1480U	
NAME OF SUBMITTER:	RANDY A. NORANBROCK	
SIGNATURE:	/Randy A. Noranbrock/	
DATE SIGNED:	09/18/2020	
Total Attachments: 1		
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AP-27016-D-VS-68

PATENT
REEL: 053818 FRAME: 0337